



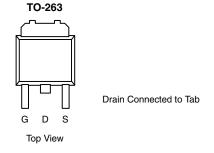
P-Channel 40-V (D-S) MOSFET

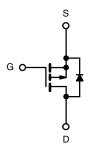
PRODUC	PRODUCT SUMMARY				
V _{DS} (V)	$r_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)		
- 40	0.005 at V _{GS} = - 10 V	- 110	185 nC		

FEATURES

• TrenchFET® Power MOSFET







Ordering Information: SUM110P04-05-E3 (Lead (Pb)-free)

P-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 40	V		
Gate-Source Voltage		V _{GS}	± 20	V	
	T _C = 25 °C		- 110 ^a	A	
Continuous Proin Current (T. = 175 °C)	T _C = 70 °C		- 110 ^a		
Continuous Drain Current (T _J = 175 °C)	T _A = 25 °C	I _D	39 ^{b, c}		
	T _A = 70 °C	1	33 ^{b, c}		
Pulsed Drain Current		I _{DM}	240		
Continuous Source-Drain Diode Current	T _C = 25 °C	l.	110		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	10 ^{b, c}		
Avalanche Current	L = 0.1 mH	I _{AS}	75		
Single-Pulse Avalanche Energy		E _{AS}	281	mJ	
	T _C = 25 °C		375		
Maximum Dayyar Dissination	T _C = 70 °C	P _D	262	w	
Maximum Power Dissipation	T _A = 25 °C	LD	15 ^{b, c}		
	T _A = 70 °C		10.5 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	
Soldering Recommendations (Peak Temperature) ^{d,}		260			

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R_{thJA}	8	10	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	0.33	0.4	C/VV

Notes:

- a. Package limited.b. Surface Mounted on 1" x 1" FR4 board.
- d. Maximum under Steady State conditions is 40 °C/W.

SUM110P04-05

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 40			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 40		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	η = 250 μπ		- 5.5		IIIV/ C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 2	- 3	- 4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtaga Dvain Current	1	V _{DS} = - 40 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 40 V, V _{GS} = 0 V, T _J = 55 °C			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = -10 \text{ V}$	- 120			Α	
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = - 10 V, I _D = - 20 A		0.0041	0.005	Ω	
Forward Transconductance ^a	g _{fs}	V _{DS} = - 15 V, I _D = - 20 A		75		S	
Dynamic ^b							
Input Capacitance	C _{iss}			11300			
Output Capacitance	C _{oss}	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		1510		pF	
Reverse Transfer Capacitance	C _{rss}			1000		1	
Total Gate Charge	Q_g			185	280		
Gate-Source Charge	Q_{gs}	V _{DS} = - 20 V, V _{GS} = - 10 V, I _D = - 110 A		48		nC	
Gate-Drain Charge	Q_{gd}			42			
Gate Resistance	R_{g}	f = 1 MHz		4.0		Ω	
Turn-On Delay Time	t _{d(on)}			25	40		
Rise Time	t _r	$V_{DD} = -20 \text{ V}, R_{L} = 0.18 \Omega$		290	440		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 110 A, V_{GEN} = - 10 V, R_g = 1 Ω		110	165	ns	
Fall Time	t _f			35	55	İ	
Drain-Source Body Diode Characteristic	s			•			
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 110	۸	
Pulse Diode Forward Current ^a	I _{SM}				- 240	A	
Body Diode Voltage	V _{SD}	I _S = - 20 A		- 0.8	- 1.5	V	
Body Diode Reverse Recovery Time	t _{rr}			70	105	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 20 A, di/dt = 100 A/μs, T _{.I} = 25 °C		130	200	nC	
Reverse Recovery Fall Time	t _a	$\frac{1}{1} = \frac{1}{2} = \frac{1}$		37			
Reverse Recovery Rise Time	t _b					ns	

Notes:

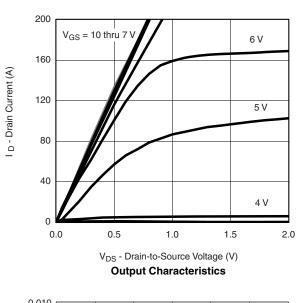
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

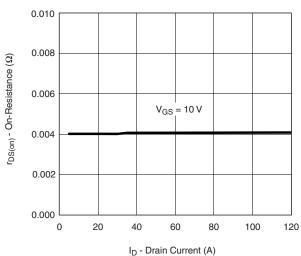
a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

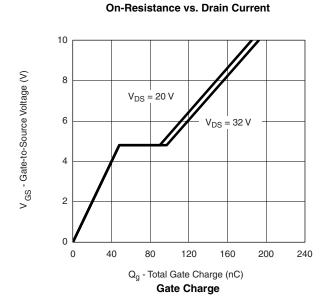
b. Guaranteed by design, not subject to production testing.

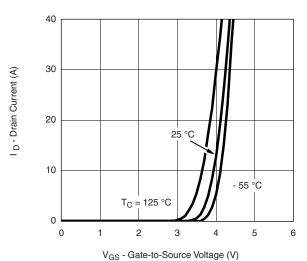


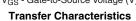
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

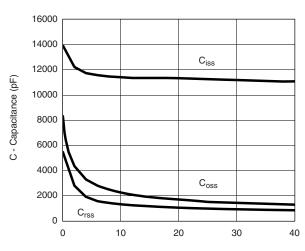




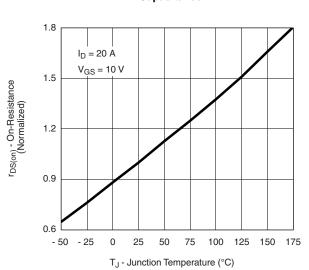








V_{DS} - Drain-to-Source Voltage (V) **Capacitance**

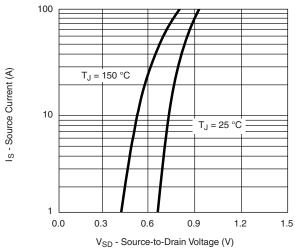


On-Resistance vs. Junction Temperature

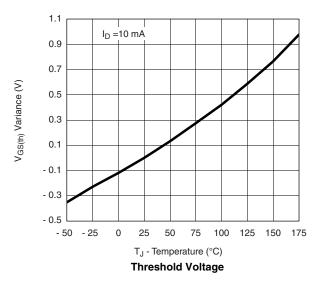
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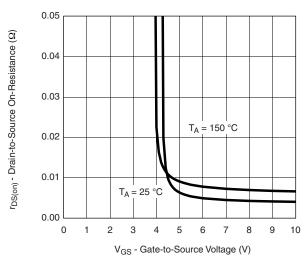
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

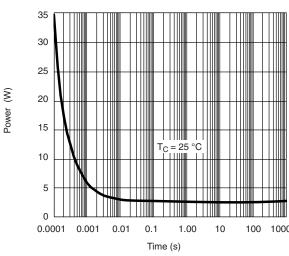


Source-Drain Diode Forward Voltage

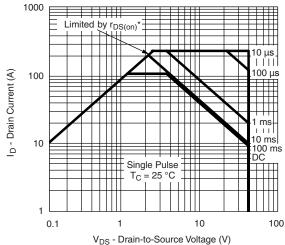




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



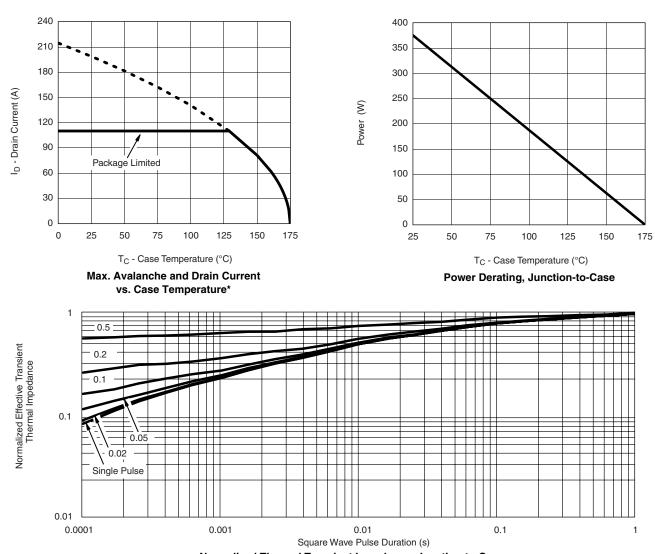
 $^*V_{GS}$ > minimum V_{GS} at which $r_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Case

5



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

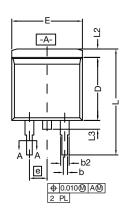
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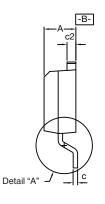
^{*} The power dissipation PD is based on TJ(max) = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

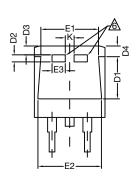
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TO-263 (D²PAK): 3-LEAD

VERSION 1: FACILITY CODE = T

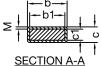








DETAIL A (ROTATED 90°)



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Notes

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6. This feature is for thick lead.

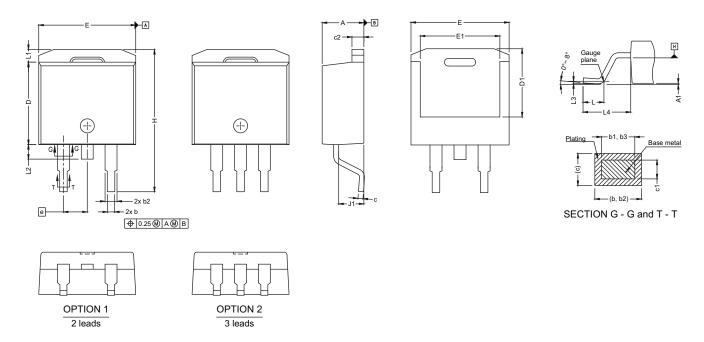
		INC	HES	MILLIN	METERS
DIM.		MIN.	MAX.	MIN.	MAX.
Α		0.160	0.190	4.064	4.826
	b	0.020	0.039	0.508	0.990
	b1	0.020	0.035	0.508	0.889
	b2	0.045	0.055	1.143	1.397
c*	Thin lead	0.013	0.018	0.330	0.457
C	Thick lead	0.023	0.028	0.584	0.711
c1	Thin lead	0.013	0.017	0.330	0.431
Ci	Thick lead	0.023	0.027	0.584	0.685
	c2	0.045	0.055	1.143	1.397
	D	0.340	0.380	8.636	9.652
	D1	0.220	0.240	5.588	6.096
	D2	0.038	0.042	0.965	1.067
	D3	0.045	0.055	1.143	1.397
	D4	0.044	0.052	1.118	1.321
	Е	0.380	0.410	9.652	10.414
	E1_	0.245	-	6.223	-
	E2	0.355	0.375	9.017	9.525
	E3	0.072	0.078	1.829	1.981
	е	0.100	BSC	2.54	BSC
	K	0.045	0.055	1.143	1.397
	L 0.57		0.625	14.605	15.875
	L1 0.090 0.110		0.110	2.286	2.794
	L2 0.040 0.055 1.016		1.397		
	L3 0.050		0.070	1.270	1.778
	L4 0.010		BSC	0.254	BSC
	М	-	0.002	-	0.050



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VERSION 2: FACILITY CODE = N



DIM.	MIN.	MAX.	
A	4.36	4.56	
A1	0	0.25	
b	0.70	0.90	
b1	0.51	0.89	
b2	1.20	1.46	
b3	1.17	1.37	
С	0.38	0.694	
c1	0.38	0.534	
c2	1.19	1.34	
D	8.60	9.00	
D1	6.9	7.5	
E	10.15	10.55	
E1	8.1	8.7	
е	2.54	BSC	
Н	15.0	15.6	
L	1.9	2.5	
L1	-	1.65	
L2	-	1.78	
L3	0.25 typ.		
L4	4.78	5.28	
J1	2.56	2.96	

DWG: 5843





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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